

Supporting Information for:

CO₂ Hydrogenation to CH₃OH on Supported Cu Nanoparticles: Nature and Role of Ti in Bulk Oxides vs. Isolated Surface Sites

Gina Noh,[†] Scott R. Docherty,[†] Erwin Lam,[†] Xing Huang,^{†,‡} Deni Mance,[†] Jan L. Alfke,[†] Christophe Copéret^{,†}*

[†] Department of Chemistry and Applied Biosciences and [‡] Scientific Center for Optical and Electron Microscopy, ETH Zürich, 8093 Zürich, Switzerland

Figure S1. Powder X-ray diffraction patterns for TiO₂₋₁₂₀ and Cu/TiO₂

Figure S2. CO chemisorption isotherms for Cu/TiO₂ and Cu/TiO_x-SiO₂

Figure S3. Additional micrographs for Cu/TiO₂ during in situ reducing treatments.

Figure S4. Cu particle size histogram and sample micrograph for Cu/TiO₂, introduced to the microscope under inert conditions

Figure S5. Cu particle size histograms and sample micrographs for Cu/SiO₂, exposed to air for >12 h and then reduced in situ in the transmission electron microscope.

Figure S6. Cu particle size histogram and sample micrograph for Cu/TiO_x-SiO₂, introduced to the microscope under inert conditions or exposed to air for >12 h.

Figure S7. Cu particle size histogram and sample micrograph for Cu/Ti₂@SiO₂, introduced to the microscope under inert conditions

Figure S8. Cu particle size histogram and sample micrograph for Cu/Ti@SiO₂, introduced to the microscope under inert conditions

Figure S9. Tauc plots for Ti-containing supports.

Section S10. Grafting and thermal treatment of a Ti^{III} precursor on SiO₂.

Section S11. Supplemental reaction data.

Figure S14. Pyridine desorption IR

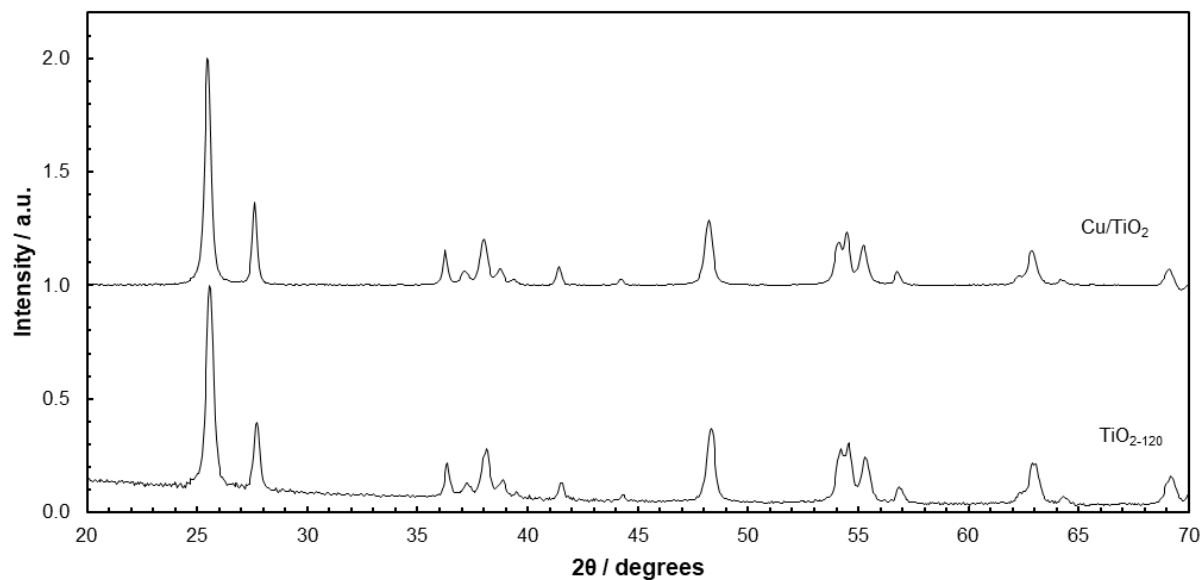


Figure S1. Powder X-ray diffraction patterns for TiO₂₋₁₂₀ (bottom; Degussa/Evonik P25) and Cu/TiO₂ (top). Patterns with and without Cu are identical, indicating that the TiO₂ support retains long-range order after dispersal of Cu nanoparticles and thermal treatments.

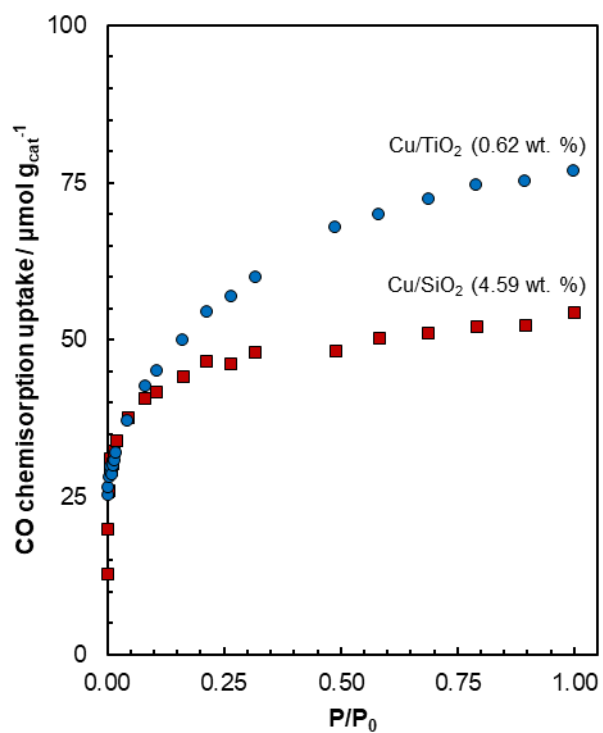


Figure S2. CO chemisorption isotherms for Cu/TiO₂ (blue) and Cu/SiO₂ (red) at 313 K. The specific CO uptake for Cu/TiO₂ is much greater than for Cu/SiO₂ in spite of having seven-fold less Cu per g_{cat} (0.62 wt. % vs. 4.59 wt. %).

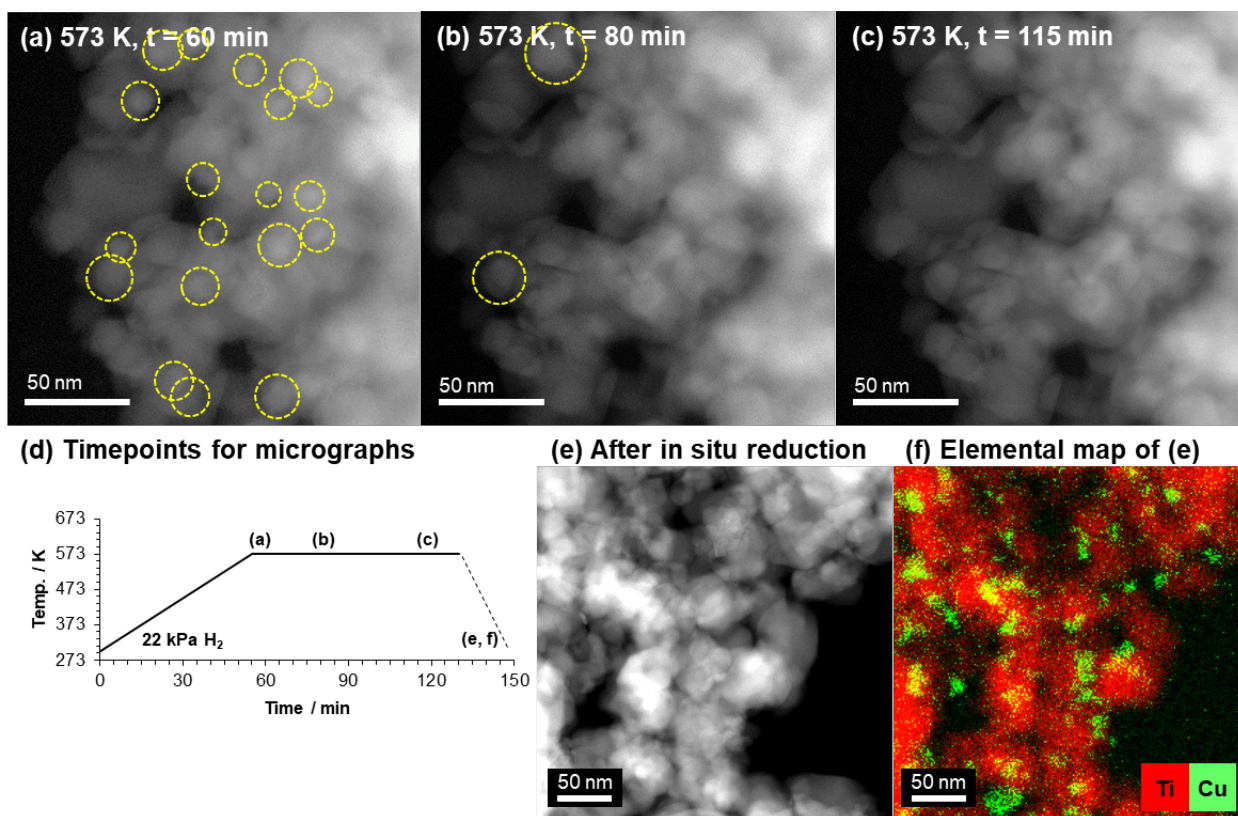


Figure S3. In situ reduction transmission electron microscopy experiment for Cu/TiO₂. Timepoints for representative micrographs, taken in the same spot with the shutter closed between images to avoid beam damage, are shown in (a), (b), and (c). The yellow circles represent Cu particles where they remain discernible from the TiO₂ support. (d) Schematic of the conditions during in situ reduction experiments, indicating the timepoints for micrographs. (e) Representative micrograph after reduction, and (f) elemental mapping of (e) using EDX.

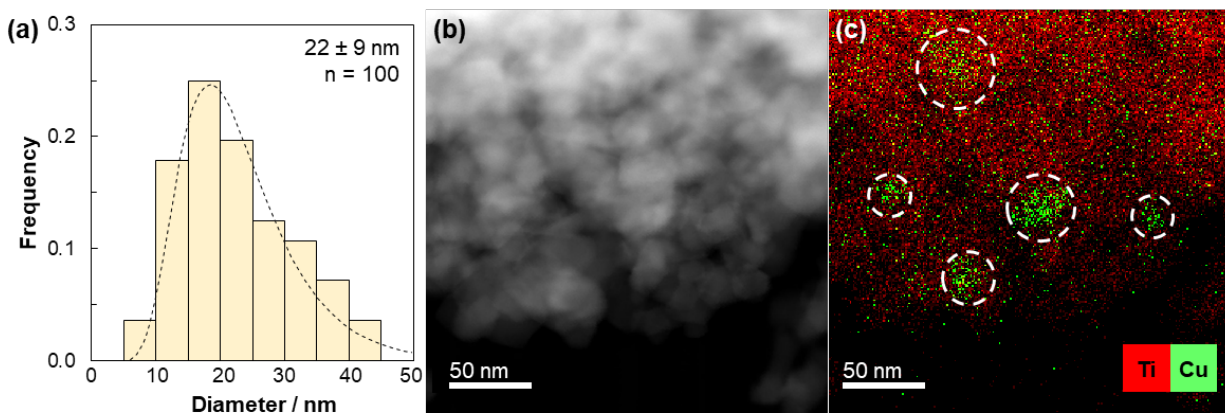


Figure S4. (a) Cu particle size histogram, (b) sample micrograph, and (c) elemental mapping using EDX, for Cu/TiO₂, introduced to the microscope under inert conditions. Dashed line in (a) represents the fitted log-normal distribution.

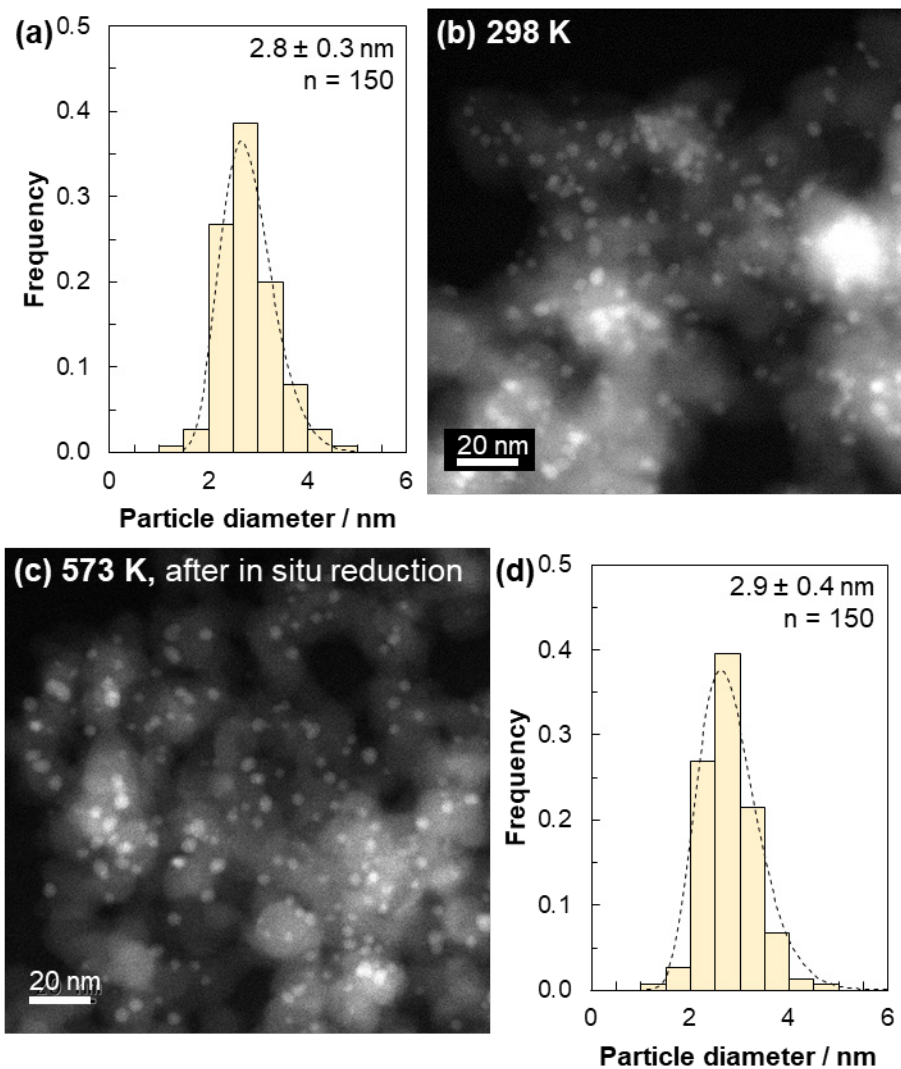


Figure S5. (a) Cu particle size histogram and (b) sample micrographs for Cu/SiO₂ exposed to air for >12 h prior to introduction to the microscope, and (c), (d) after *in situ* reduction treatment (573 K (5 K min⁻¹) for 1 h, 22 kPa H₂, 0.16 cm³ min⁻¹).

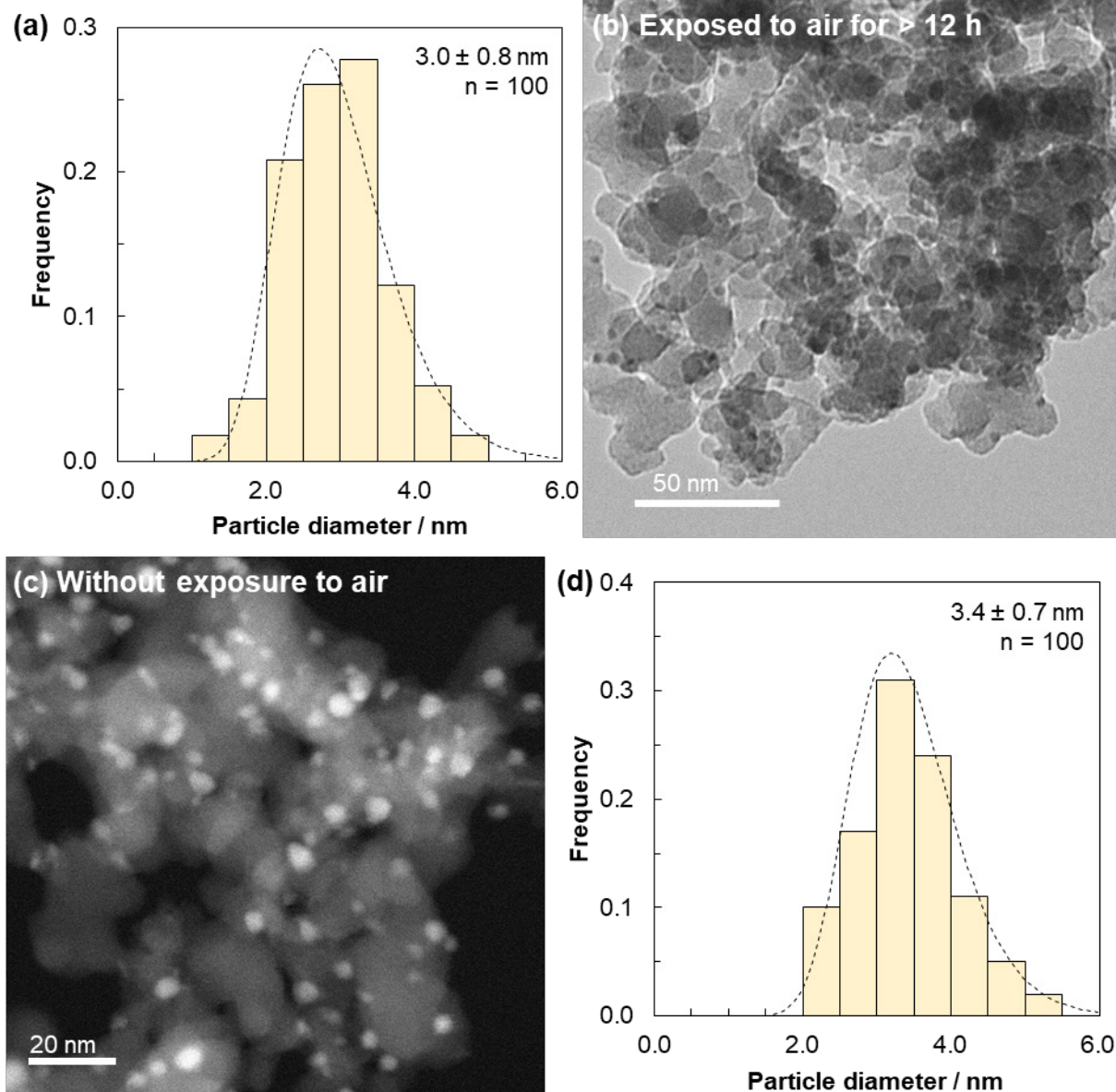


Figure S6. (a) Cu particle size histogram and (b) sample micrographs for Cu/TiO_x-SiO₂ exposed to air for >12 h prior to introduction to the microscope, and (c), (d) for Cu/TiO_x-SiO₂ transferred to the microscope without exposure to air. Bright-field images were obtained using a Hitachi HT7700 microscope (100 kV).

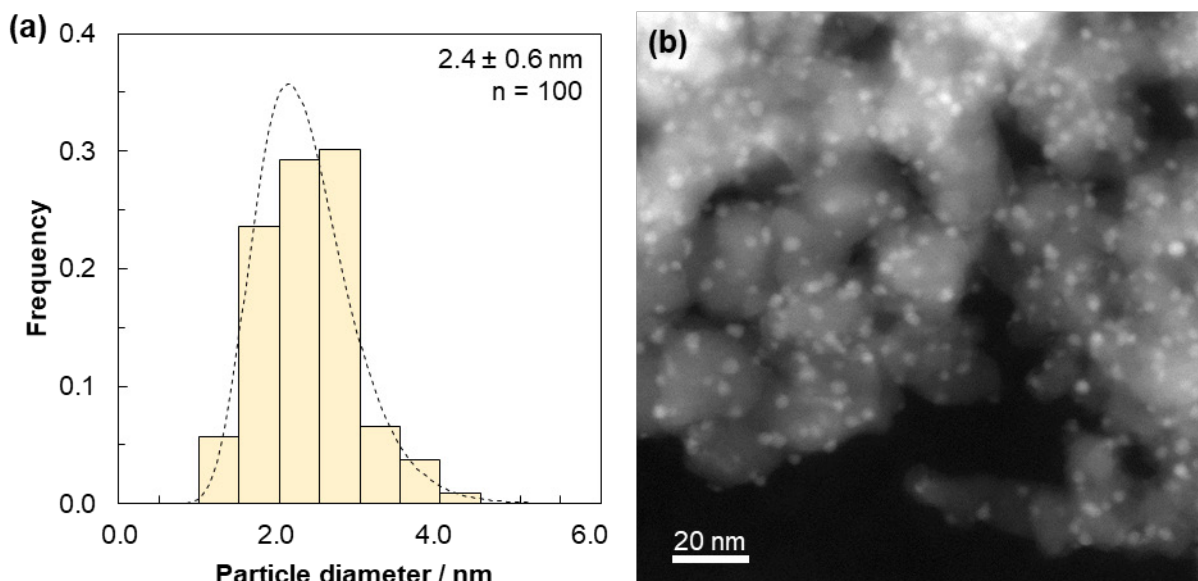


Figure S7. (a) Cu particle size histogram and (b) sample micrographs for Cu/Ti₂@SiO₂ transferred to the microscope without exposure to air.

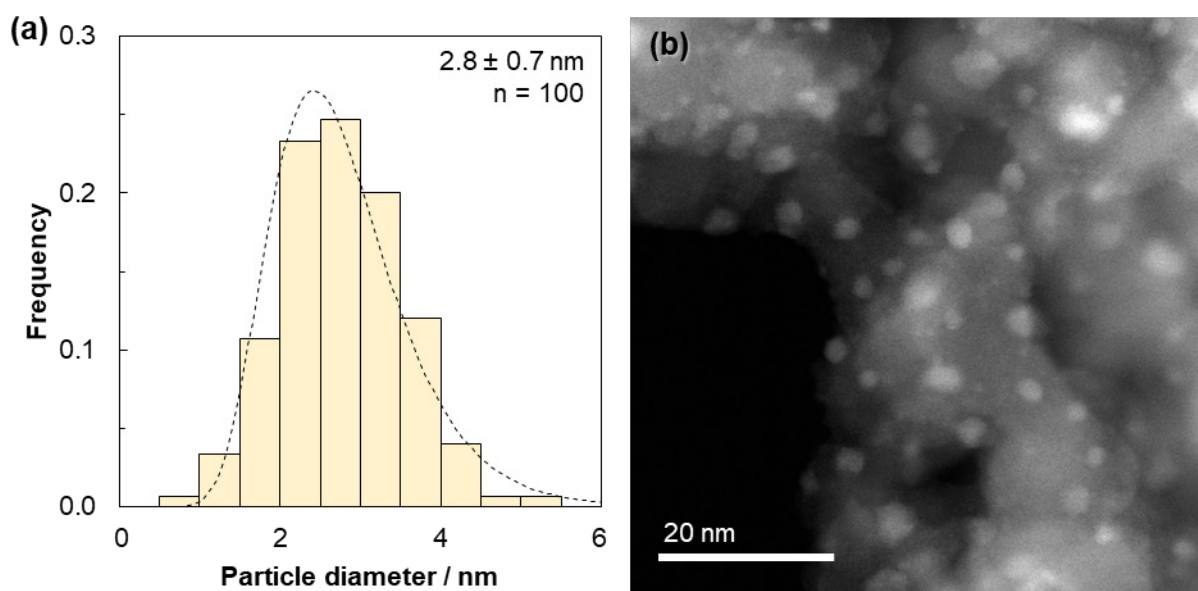


Figure S8. (a) Cu particle size histogram and (b) sample micrographs for Cu/Ti@SiO₂ transferred to the microscope without exposure to air. Micrographs of the materials exposed to air are included in previous work.¹

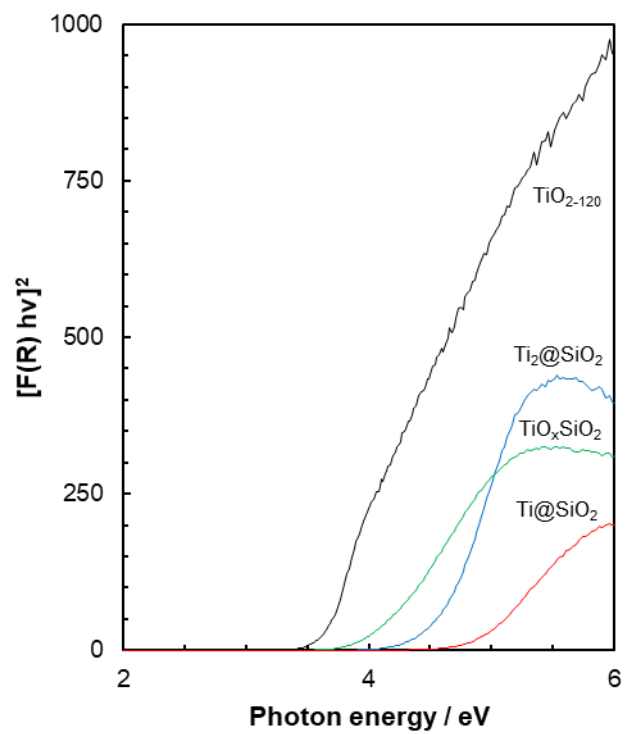


Figure S9. Tauc plot for Ti-containing supports. Values of the optical bandgap were obtained by extrapolating the linear region of the curves to zero $[F(R) hv]^2$ values and are included in Table 1 of the main text.

Section S10. Grafting and thermal treatment of a Ti^{III} precursor on SiO_2 .

To examine the stability of Ti^{III} metal centers dispersed on SiO_2 , a Ti^{III} precursor ($\text{Ti}(\text{OSi}(\text{O}^t\text{Bu})_3)_3$, prepared according to literature procedures²) was grafted onto SiO_{2-700} then thermally treated. The material was examined using EPR spectroscopy (Figure S10). A solution of $\text{Ti}(\text{OSi}(\text{O}^t\text{Bu})_3)_3$ in toluene (0.15 mmol; 20 mL) was added to a slurry of SiO_{2-700} (1 g) in toluene (10 mL) then stirred for 12 h; the slurry was allowed to settle, then the supernatant was decanted. The material was rinsed three times with toluene then dried under vacuum ($\sim 10^{-3}$ Pa) at room temperature, followed by treatment under vacuum ($\sim 10^{-3}$ Pa) at 773 K (0.083 K.s^{-1}) for 5 h.

The prominent EPR signal for Ti^{III} ($g = 1.96$) disappears after thermal treatment. This suggests that the small amounts of water generated during decomposition of (O^tBu) ligands during thermal treatments are sufficient to oxidize Ti^{III} to Ti^{IV} , essentially irreversibly. The EPR spectrum for the material treated under reducing conditions (under H_2 flow (101 kPa) at 773 K (0.083 K.s^{-1}) for 5 h) is identical to the spectrum for the material treated under vacuum.

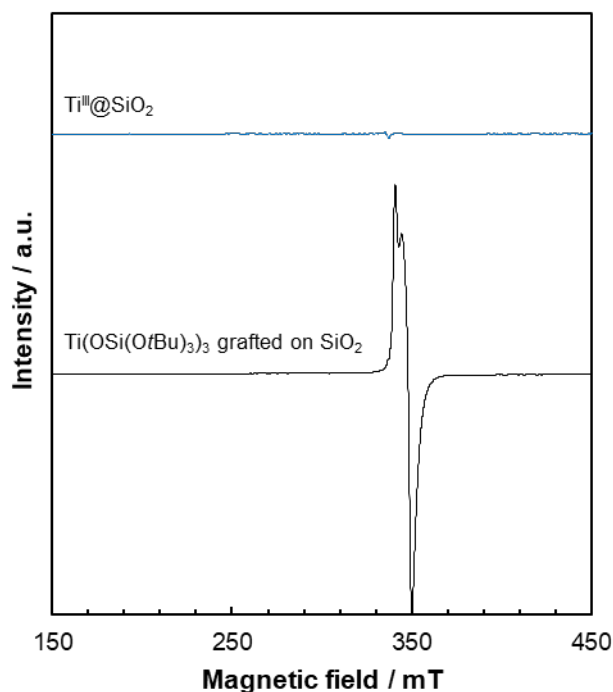


Figure S10. EPR spectra (100 K, X band) of $\text{Ti}(\text{OSi}(\text{O}^t\text{Bu})_3)_3$ grafted on SiO_2 (bottom) and after thermal treatment (top).

Section S11. Supplemental catalytic reaction data

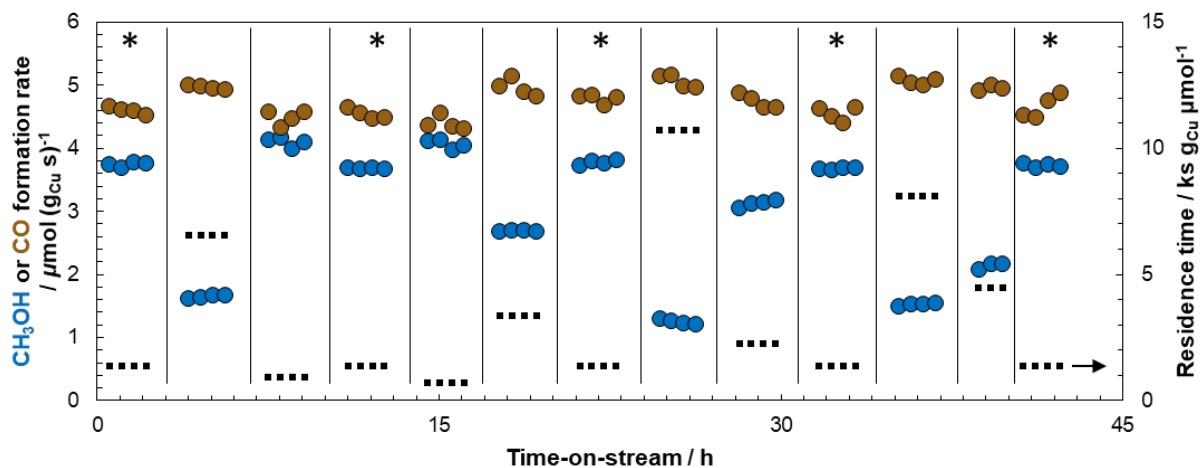


Figure S11. CH₃OH (blue, left axis) and CO (brown, left axis) formation rates and CO₂ residence time (black, right axis) as a function of time-on-stream for CO₂ hydrogenation reactions on Cu/SiO₂ (503 K, 2.5 MPa total pressure; 1:3:1 CO₂:H₂:Ar).

* Reference conditions used to monitor catalyst deactivation as a function of time-on-stream.

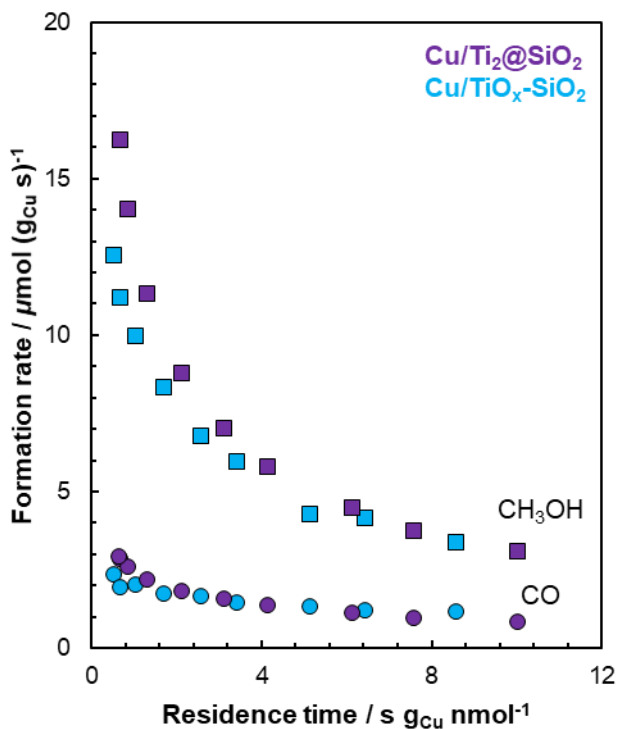


Figure S12. CH₃OH (squares) and CO (circles) formation rates as a function of CO₂ residence time for Cu/Ti₂@SiO₂ and Cu/TiO_x-SiO₂ (503 K, 2.5 MPa total pressure; 1:3:1 CO₂:H₂:Ar).

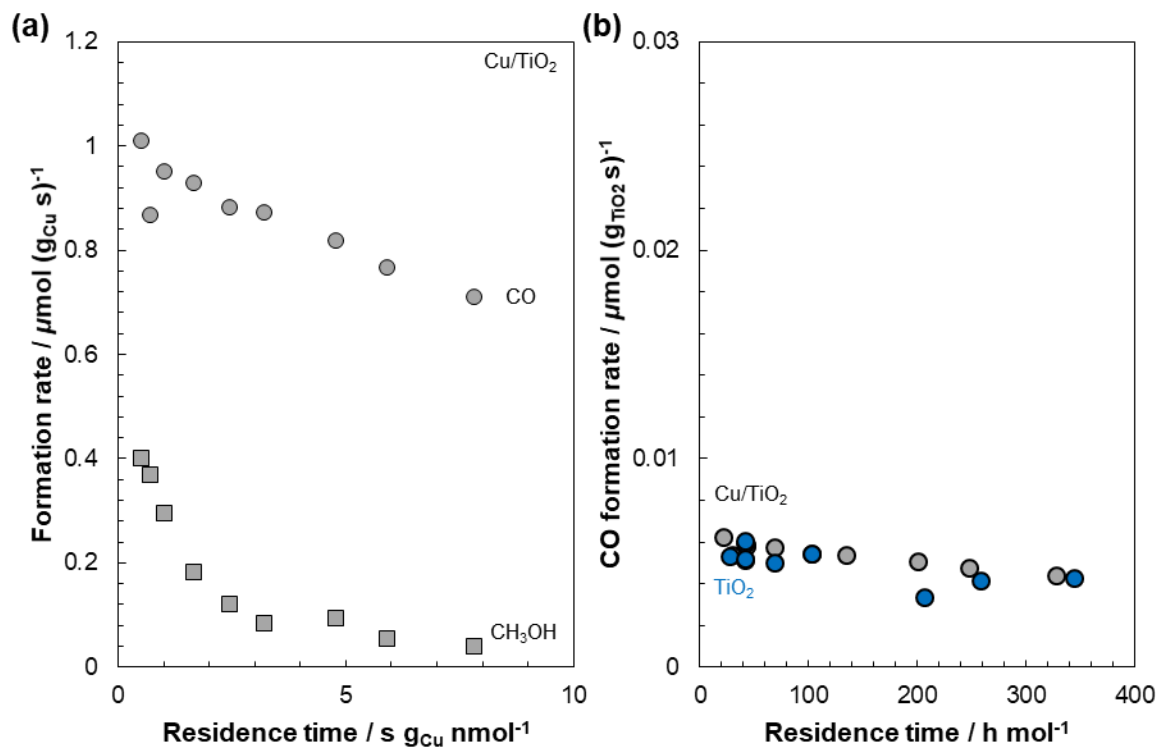


Figure S13. (a) CH_3OH (squares) and CO (circles) formation rates on Cu/TiO_2 , normalized by mass of Cu. CO formation rates include contributions from the support. **(b)** CO formation rates, normalized by the mass of TiO_2 , on Cu/TiO_2 (grey) and TiO_2 (blue). 503 K, 2.5 MPa total pressure; 1:3:1 $\text{CO}_2\text{:H}_2\text{:Ar}$.

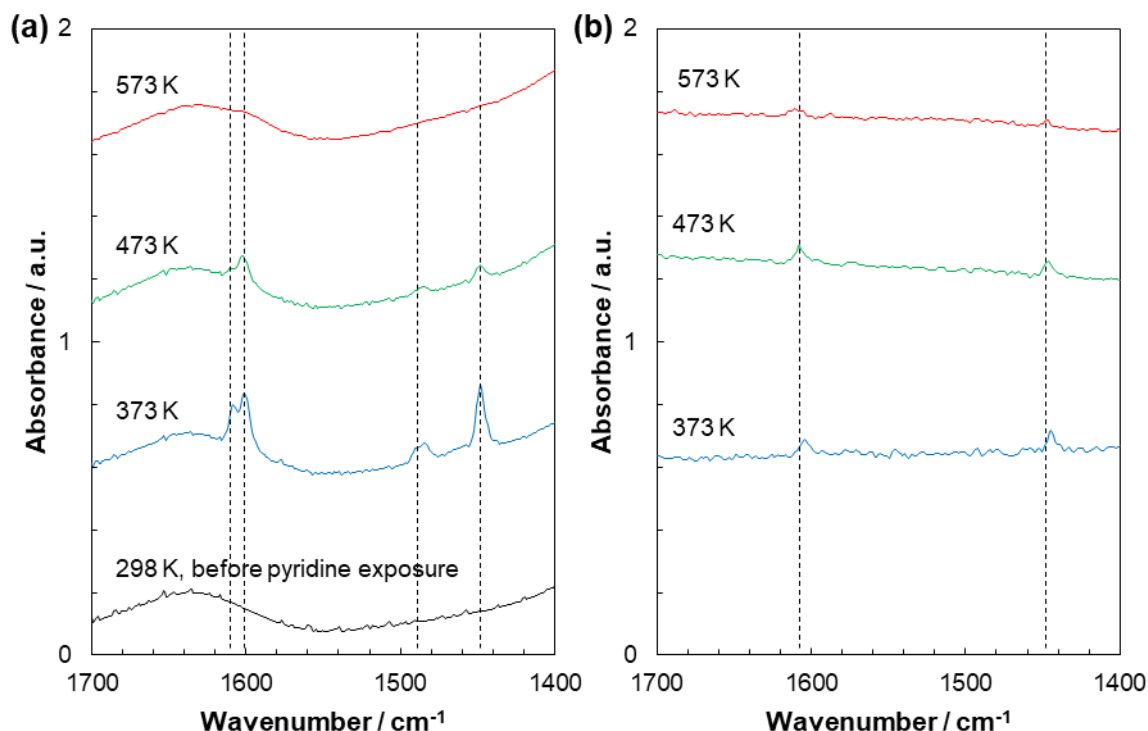


Figure S14. (a) Transmission IR spectra for Cu/Ti@SiO₂ and (b) ATR IR spectra for Cu/TiO₂ after exposure of the sample to pyridine (0.2 Pa at 298 K for 5 min), followed by evacuating ($\sim 10^{-3}$ Pa) at 373 K (blue line), 473 K (green line), and 573 K (red line) for 15 minutes. Dashed lines highlight pyridine vibrational bands.

References

- (1) Noh, G.; Lam, E.; Alfke, J. L.; Larmier, K.; Searles, K.; Wolf, P.; Copéret, C. Selective Hydrogenation of CO₂ to CH₃OH on Supported Cu Nanoparticles Promoted by Isolated Ti^{IV} Surface Sites on SiO₂. *ChemSusChem* **2019**, 12 (5), 968–972.
- (2) Allouche, F. Structure – Activity Relationship in Olefin Polymerization with Well-Defined Ti(III) and Ln(II) Molecular and Surface Complexes, ETH Zurich, 2018.